
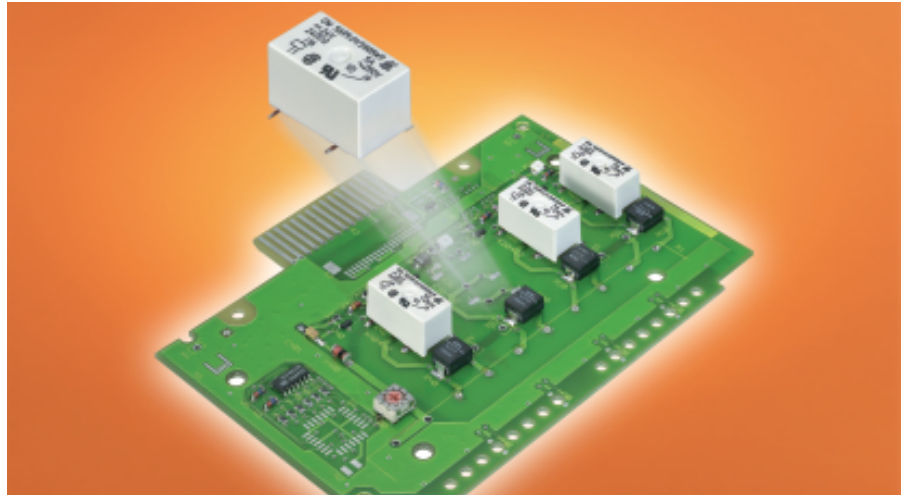


Miniature relay, monostable dilais® OW 5699, SMD model



- according to IEC/EN 60 255
- Power miniature relay for SMD mounting
- high switching power AC 250 V / 5 A
- high dielectric strength 4 kV
- high limiting continuous current $I_{th} = 5 A$
- compact size $V = 2,47 \text{ cm}^3$
- safe separation $L + K \geq 5,5 \text{ mm}$
- EN 50 178
- Approval: 

SMT / SMD (Surface Mounting Technology) for Reflow-soldering
THT (Through Hole Technology) for Reflow-soldering



Technical data

Relay type		OW 5699
1. 0 Relay coil		
1. 1 Nominal voltage	DC V	4,5, 6, 12, 20, 24, 48
1. 2 Nominal consumption	mW	250 (1 NO), 310 (1 changeover contact)
2. 0 Contacts		
2. 1 Contact arrangement		1 NO, 1 changeover contact
2. 2 Contact material		AgSnO ₂ , AgNi 0,15 ¹⁾
2. 3 Rated insulation voltage	AC	250 V
Switching voltage min./max.	V	AC/DC 10 / DC 120, AC 250 ¹⁾
2. 4 Limiting continuous current I_{th}	A	5
Switching current min./max.	A	0,01 ²⁾ / 5
2. 5 Switching power min./max.	VA	0,1 / 1 250
Switching power min./max.	W	0,1 / 120
2. 6 Switching capacity		
to IEC/EN 60 947-5-1 AC 15	AC V/A	NC: 230 / 1 NO: 230 / 3
2. 7 Electrical life		
at AC 230 V 1 A $\cos \varphi = 1$	switching cycles	> 5 x 10 ⁵
at AC 230 V 5 A $\cos \varphi = 1$	switching cycles	> 1,5 x 10 ⁵
2. 8 max. Switching frequency	switching cycles/s	20
2. 9 Response time / Release time	ms	≤ 8 (typ. 5) / ≤ 4 (typ. 2)
2.10 Contact force	cN	8 (1 NO), 8 (1 changeover contact, NC and NO)
3. 0 Other		
3. 1 Mechanical life	switching cycles	≥ 5 x 10 ⁷
3. 2 Temperature range	°C	- 40 ... + 80
3. 3 Degree of protection Housing, Connect.	IP 67; IP 00	IEC/EN 60 529, wash proof as per Qc 2 IEC/EN 60 068-2-17
3. 4 Housing material		Thermoplast GF PA
3. 5 Vibration resistance		10 ... 55 Hz; 1,2 mm amplitude; 10 g max. IEC/EN 60 068-2-6

¹⁾ Special version gold plated contacts with 3 μm Au for small loads (0,1 ... 60 V, 1 ... 300 mA) on request ²⁾ Typical values

Technical data

3. 6 Climate resistance	20 / 080 / 04 (climate category); A/B/D IEC/EN 60 068-1	
3. 8 Insulation according to IEC 60 664-1		
Rated insulation voltage	AC V	250
Contamination level		3
Overvoltage category		III
Test voltage contact-coil (1 min)	AC kV eff.	≥ 4
Clearance and creepage distances as per EN 50 178	mm	5,5
3. 9 Weight	g	approx. 5
3.10 Soldering: Reflow-convection soldering		max. 260°C; 10 s

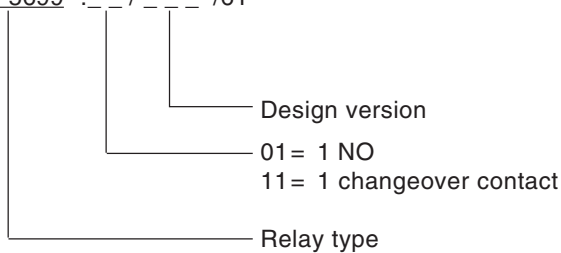
Coil data with design version

Nominal voltage V	Voltage range V	Resistance at 20°C Ω (±10%)	OW 5699.01/_ _ _	
			AgSnO ₂ + 0,3 μm Au	AgNi 0,15 + 0,3 μm Au
4,5	3,0 ... 9,9	78	351	371
6	4,3 ... 13,2	155	352	372
12	8,0 ... 26,4	600	353	373
20	13,0 ... 44,0	1 600	354	374
24	16,0 ... 52,8	2 400	355	375
48	32,0 ... 105,0	9 216	356	376

Nominal voltage V	Voltage range V	Resistance at 20°C Ω (±10%)	OW5699.11/_ _ _	
			AgSnO ₂ + 0,3 μm Au	AgNi 0,15 + 0,3 μm Au
4,5	3,3 ... 7,2	65	361	381
6	4,5 ... 9,6	115	362	382
12	9,0 ... 19,2	465	363	383
20	15,0 ... 32,0	1 250	364	384
24	18,0 ... 38,4	1 860	365	385
48	36,0 ... 76,8	6 310	366	386

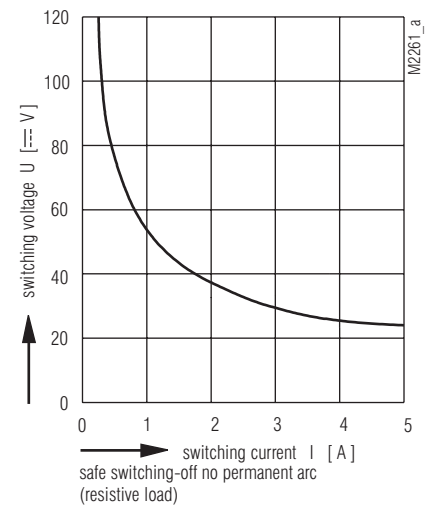
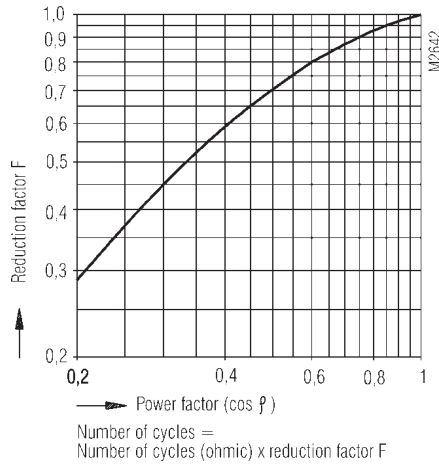
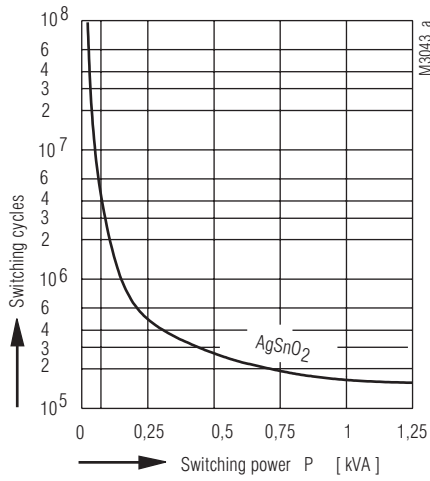
Ordering example

OW 5699 . _ _ / _ _ _ /61*)



*) /61 cURus approval

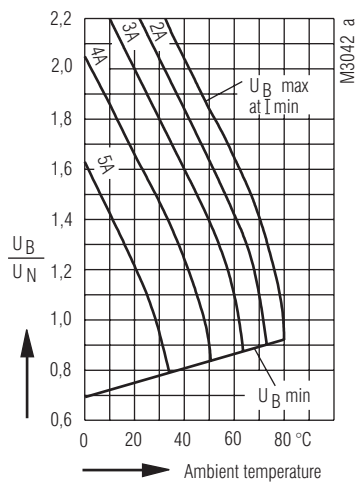
Characteristics



Contact service life

Reduction factor for inductive loads

Limit curve for arc-free operation



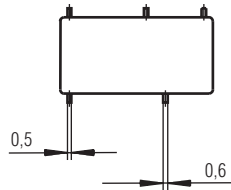
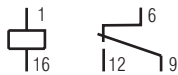
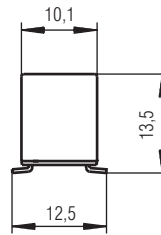
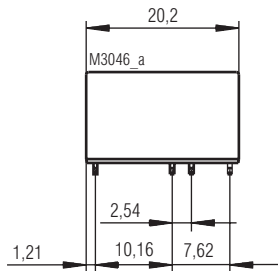
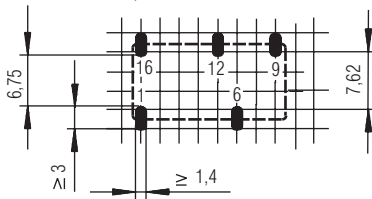
Operating voltage limit curve

Dimensions, pin configuration, connection diagrams

Drilling plan (solder side)

OW 5699.11 SMD

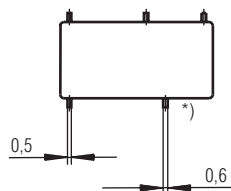
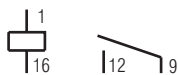
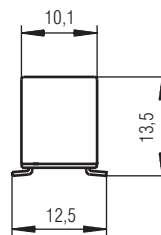
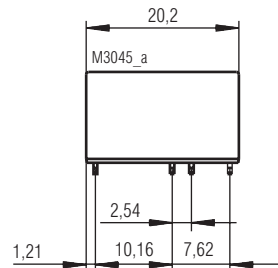
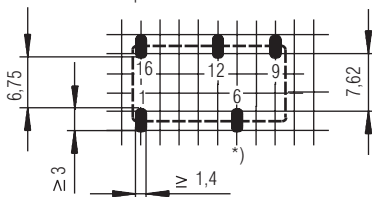
PCB connection grid
top view



The tolerance of all pins being on the same level is +0,1

OW 5699.01 SMD

PCB connection grid
top view



The tolerance of all pins being on the same level is +0,1
*) Pin 6 and Pin 9 have same potential in initial state

Connection for basic grid dimensions 2,5 mm as well as 2,54 mm according to IEC/EN 60 097 and IEC 60 326 average